



Product Change Notification

110538 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

America's OEM's Contact:

Krista Gottschalk Phone: (503) 712-8026 Email: krista.r.gottschalk@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 110538 - 01
Change Title: Intel® Centrino® Wireless-N 1030 SKUs:
11230BN.HMWG; 11230BN.HMWWB
PCN 110538-01, Product Design
MAC Substrate Change
Reason for Revision: Add new manufacturing
Site Code
Date of Publication: May 20, 2011

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 27, 2011
Date of First Availability of Post-Conversion Material:	May 27, 2011

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

Reason for Revision: Add new manufacturing Site Code

1. During year 2012 product development a new substrate design provided improved noise immunity on the C-Link interface. To provide ongoing quality improvements Intel is implementing similar design to existing year 2011 products.
2. Update to Intel tracking number in 2D barcode for new manufacturing site.

Customer Impact of Change and Recommended Action:

Customer will receive product with the following changes:

1. Update MAC Substrate on Intel® Centrino® Wireless-N 1030 product.
2. Product and Distribution labels will include additional site code of WZ.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only. No change to form fit or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Board Products Table :

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA	Post-Change TA
11230BN.HMWG	907747	907747	G13407-004	G13407-005
11230BN.HMWWB	907750	907750	G23704-001	G23704-002

PCN Revision History:

Date of Revision:

March 25, 2011

May 20, 2011

Revision Number:

00

01

Reason:

Originally Published PCN

Add new manufacturing Site Code